

**SPECIFICATIONS**

Contact Material: Tin Plating at Solder Tail  
Gold Plating at Mating, Nickel over all

Contact Resistance: 30mΩ Max

Housing Material: Glass Filled High Temp Nylon, Black

Insulation Resistance: 1000MΩ Min

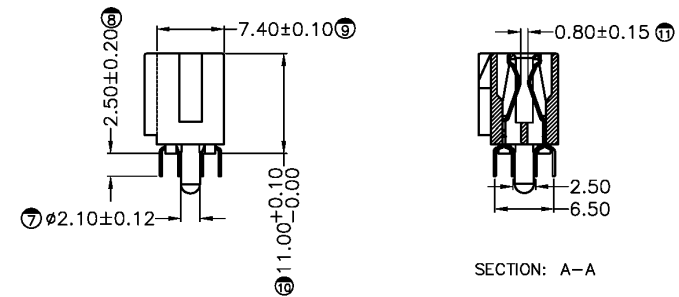
Insertion Force: 0.115Kg Max

Withdrawal Force: 0.015Kg Min

Retention Force: 0.5Kg Min

Withstanding: 500V AC

Operating Temp: -55°C ~ +85°C



Dimensions				
Pins	A	B	C	D
36	7.65	6.00	25.00	9.15
64	21.65	20.00	39.00	23.15
98	38.65	37.00	56.00	40.15
164	71.65	70.00	89.00	73.15

PCB LAYOUT

RoHS compliant

Rev.	Description	Date	Approved	Drawing	Name	Date
				Approved	Howard	08/10/99
				Checked	Lizzy	08/10/99
				Drawn	Tina	08/10/99
				0.0 ± 0.35	0.00 ± 0.20	Angles ± 3'
						UNIT: mm

**Central Components Manufacturing**  
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Part No.: **CCE-PCI-CB100-XX-SC**

Description: PCI card edge connector